

## NOTES FOR FABRICATION:

THIS DATA OVERRIDES ANSWERS GIVEN IN QUESTIONAIRE:

Layers = 2
TG material is 170 or greater FR4
Board thickness smaller section = .8
Board thickness larger section = .8 to 1.6 as convenient
Min hole size = .254 mm = 10 mil
Min track spacing = .2 mm = 7.87 mil
Default solder mask, both sides
White silkscreen, both sides
Not high frequency

## NOTES FOR ASSEMBLY:

Not controlled impedance
Not gold fingers
Preferred surface = lead free HASL
Cu weight = 2 oz

FOLLOW GERBERS EXACTLY INCLUDING:
— If this design has 2 mm holes shown between sections, those holes are not plated, and the number of design has 2 mm holes shown between sections, those holes are not plated, and the number of design has 2 mm holes in pads,
— a single sided Through Hole pad,
— silk screen on copper,
— solder mock exists in it.

- silk screen on copper,solder mask customizations,
- solder paste customizations

